

Features

- RoHS compliant*
- SMB package
- Surface mount
- High current capability

CD214B-B320 ~ B360 Schottky Barrier Rectifier Chip Diode

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Schottky Rectifier Diodes for rectification applications, in compact chip package DO-214AA (SMB) size format, which offer PCB real estate savings and are considerably smaller than competitive parts. The Schottky Rectifier Diodes offer a forward current of 3 A with a choice of repetitive peak reverse voltage of 20 V up to 60 V.

Bourns® Chip Diodes conform to JEDEC standards, are easy to handle with standard pick and place equipment and their flat configuration minimizes roll away.

Electrical Characteristics (@ TA = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD214B-					Unit
Tarameter		B320	B330	B340	B350	B360	O I III
Forward Voltage (Max.) (I _f = 3 A)	V _F	0.5	0.5	0.5	0.7	0.7	V
Typical Junction Capacitance*	C _T			250			pF
Reverse Current (Max.) at Rated V _R)	I _R	0.5		mA			

Measured at 1.0 MHz and applied reverse voltage of 4.0 V DC.

Absolute Ratings (@ TA = 25 °C Unless Otherwise Noted)

Parameter	Symbol	CD214B-					Unit
raiametei	Cyllibol	B320	B330	B340	B350	B360	
Repetitive Peak Reverse Voltage	V _{RRM}	20	30	40	50	60	V
Reverse Voltage	V _R	20	30	40	50	60	V
Maximum RMS Voltage	V _{RMS}	14	21	28	35	42	V
Avg. Forward Current	I _o	3		Α			
Forward Current, Surge Peak (60 Hz, 1 cycle)	l _{surge}	100			А		
Typical Thermal Resistance**	$R_{_{\Theta JL}}$	10			°C/W		
Storage Temperature	T _{STG}	-55 to +150		°C			
Junction Temperature	T _J	-55 to +125		°C			

^{**} Thermal resistance junction to lead.

CD 214B - B 3 30 LF Common Code Chip Diode Package • 214B = SMB/DO-214AA B = Schottky Barrier Series Reverse Voltage (V_R) Code 30 = 30 V 40 = 40 V The device characteristics and parameters in this data sheet can and do vary in

How To Order

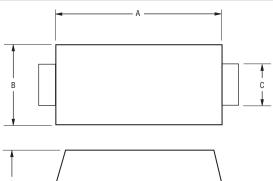
different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

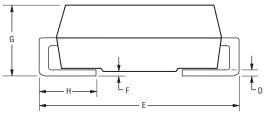
^{*}RoHS Directive 2002/95/EC Jan. 27, 2003 including annex and RoHS Recast 2011/65/EU June 8, 2011.

Specifications are subject to change without notice.

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Product Dimensions

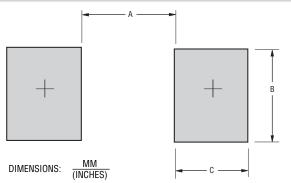




Dimension	SMB (DO-214AA)
А	4.06 - 4.57
_ ^	(0.160 - 0.180)
В	_ 3.30 - 3.94
	(0.130 - 0.155)
С	1.96 - 2.21
C	(0.078 - 0.087)
D	0.15 - 0.31
	(0.006 - 0.112)
F	5.21 - 5.59
_	(0.205 - 0.220)
F	0.05 - 0.20
	(0.002 - 0.008)
G	2.01 - 2.62
4	(0.080 - 0.103)
П	0.76 - 1.52
"	(0.030 - 0.060)

DIMENSIONS: $\frac{MM}{(INCHES)}$

Recommended Pad Layout



Dimension	SMA (DO-214AC)
Α	<u>2.90</u> (0.114)
В	3.00 (0.118)
С	2.30 (0.091)

Physical Specifications

Case	Molded plastic
Polarity	Indicated by cathode band
•	0.003 ounces / 0.093 grams

Typical Part Marking

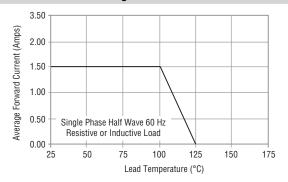
CD214B-B320	B	320B
CD214B-B330	B	330B
CD214B-B340	B	340B
CD214B-B350	B	350B
CD014B B060	B	260D

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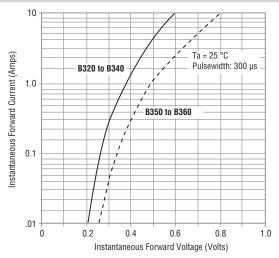
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Rating and Characteristic Curves

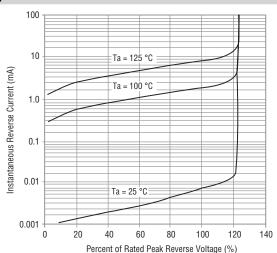
Forward Current Derating Curve



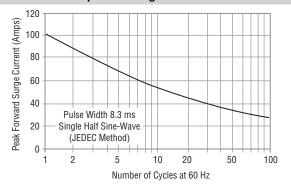
Typical Forward Characteristics



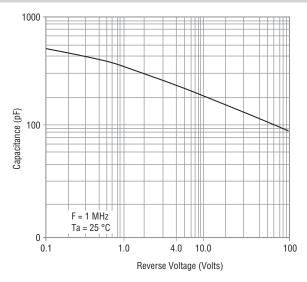
Typical Reverse Characteristics



Maximum Non-Repetitive Surge Current



Typical Junction Capacitance



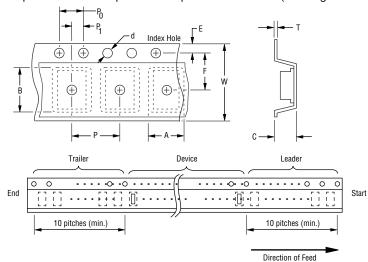
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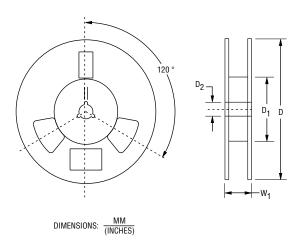
The device characteristics and parameters in this data sheet can and do vary in different applications and actual device performance may vary over time. Users should verify actual device performance in their specific applications.

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Packaging Information

The product will be dispensed in Tape and Reel format (see diagram below).





Devices are packed in accordance with EIA standard RS-481-A and specifications shown here.

Item	Symbol	SMB (DO-214AA)		
Carrier Width	A	4.94 ± 0.10		
Carrier Width	,,	(0.194 ± 0.004)		
Carrier Length	В	5.57 ± 0.10		
		(0.219 ± 0.004)		
Carrier Depth	С	$\frac{2.36 \pm 0.10}{(0.093 \pm 0.004)}$		
Comparison		1.55 ± 0.05		
Sprocket Hole	d	$\overline{(0.061 \pm 0.002)}$		
Reel Outside Diameter	D	330_		
Tice outside Diameter		(12.992)		
Reel Inner Diameter	D ₁	50.0 MIN.		
	-1	(1.969)		
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.200)}$		
	2	$(0.512 \pm 0.008) \\ 1.75 \pm 0.10$		
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$		
		$\frac{(0.069 \pm 0.004)}{5.50 \pm 0.05}$		
Punch Hole Position	F	$\frac{3.30 \pm 0.03}{(0.217 \pm 0.002)}$		
		4.00 ± 0.10		
Punch Hole Pitch	Р	$\frac{1100 \pm 0.110}{(0.157 \pm 0.004)}$		
0 1 111 5" 1		4.00 ± 0.10		
Sprocket Hole Pitch	P_0	$\overline{(0.157 \pm 0.004)}$		
Embossment Center	В	2.00 ± 0.05		
Embossment Center	P ₁	(0.079 ± 0.002)		
Overall Tape Thickness	Т	0.30 ± 0.10		
Overall Tape Trickness	•	(0.012 ± 0.004)		
Tape Width	W	12.00 ± 0.20		
Tapo Watti	• • • • • • • • • • • • • • • • • • • •	(0.472 ± 0.008)		
Reel Width	W ₁	$\frac{18.4}{(0.704)}$ MAX.		
	1	(0.724) WAX.		
Quantity per Reel		3,000		

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